

Chip beads
For power line
MPZ series



MPZ1608 type



FEATURES

- Noise reduction solution for power line.
- Because of its low DC resistance, it can handle large currents of 8A or more, optimal for low power consumption.
- Various frequency characteristics with 5 materials of different features for countermeasures against everything from general signals to high-speed signals.
- Performs well even in signal lines where low direct current resistance is required.
- Operating temperature range: -55 to +125°C

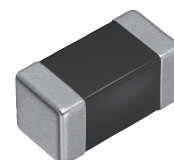
APPLICATION

- Noise removal for mobile devices such as smartphones and tablet terminals, and various modules.
- Noise suppression in power lines of base stations Noise suppression in power lines of information equipment such as PCs, servers, STBs, routers, etc. Industrial equipment such as smart grids, robots, etc.

PART NUMBER CONSTRUCTION

MPZ	1608	S	PH	220	A	T	AH0
Series name	L x W x T dimensions 1.6x0.8x0.6 mm	Material name	Internal code	Impedance (Ω) at 100MHz	Characteristic type	Packaging style	Internal code

MPZ	1608	S	471	A	T	A00
Series name	L x W x T dimensions 1.6x0.8x0.6 mm 1.6x0.8x0.8 mm	Material name	Impedance (Ω) at 100MHz	Characteristic type	Packaging style	Internal code



MPZ1608 type

CHARACTERISTICS SPECIFICATION TABLE

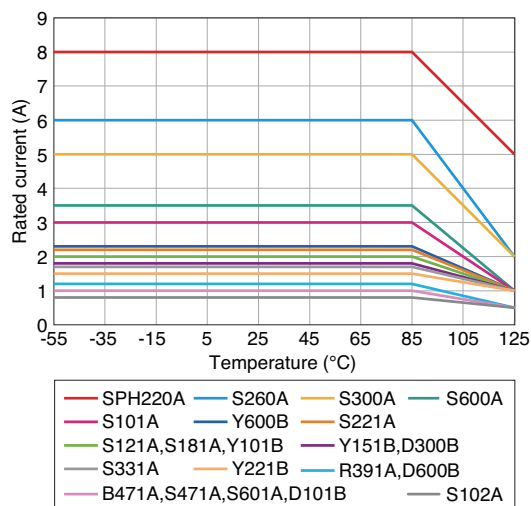
Impedance [100MHz] (Ω)		DC resistance (Ω)max.	Rated current*	Thickness T (mm)	Part No.
Tolerance			(A)max.		
470 ±25%		0.150	1.0	0.8	MPZ1608B471ATA00
22 ±7Ω		0.004	8.0	0.6	MPZ1608SPH220ATAH0
26 ±25%		0.007	6.0	0.6	MPZ1608S260ATAH0
30 ±10Ω		0.010	5.0	0.6	MPZ1608S300ATAH0
60 ±25%		0.020	3.5	0.6	MPZ1608S600ATAH0
100 ±25%		0.030	3.0	0.6	MPZ1608S101ATAH0
120 ±25%		0.045	2.0	0.6	MPZ1608S121ATAH0
180 ±25%		0.050	2.0	0.6	MPZ1608S181ATAH0
220 ±25%		0.050	2.2	0.8	MPZ1608S221ATA00
330 ±25%		0.080	1.7	0.8	MPZ1608S331ATA00
470 ±25%		0.150	1.0	0.8	MPZ1608S471ATA00
600 ±25%		0.150	1.0	0.8	MPZ1608S601ATA00
1000 ±25%		0.300	0.8	0.8	MPZ1608S102ATA00
390 ±25%		0.120	1.2	0.8	MPZ1608R391ATA00
60 ±25%		0.030	2.3	0.8	MPZ1608Y600BTA00
100 ±25%		0.040	2.0	0.8	MPZ1608Y101BTA00
150 ±25%		0.050	1.8	0.8	MPZ1608Y151BTA00
220 ±25%		0.100	1.5	0.8	MPZ1608Y221BTA00
30 ±10Ω		0.060	1.8	0.8	MPZ1608D300BTA00
60 ±25%		0.100	1.2	0.8	MPZ1608D600BTA00
100 ±25%		0.150	1.0	0.8	MPZ1608D101BTA00

Measurement equipment

Measurement item	Product No. *	Manufacturer
Impedance	4991A+16192A	Keysight Technologies
DC resistance	Type-755611	Yokogawa

* Equivalent measurement equipment may be used.

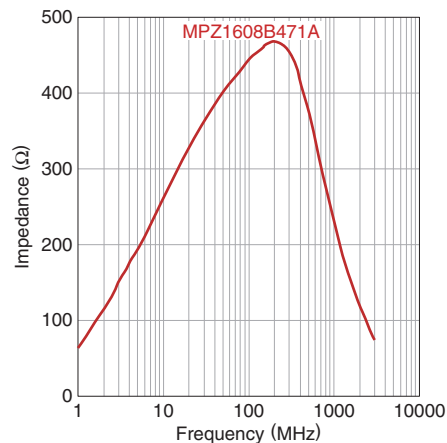
Rated current vs. temperature characteristics (derating)



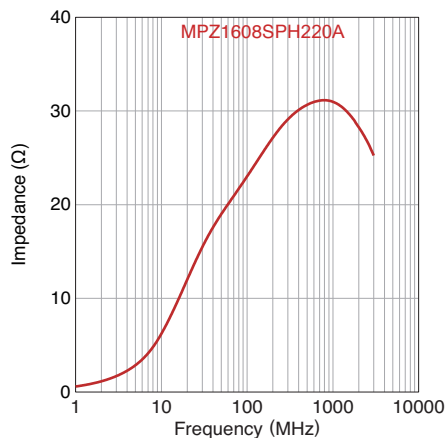
MPZ1608 type

Z VS. FREQUENCY CHARACTERISTICS (BY TYPES)

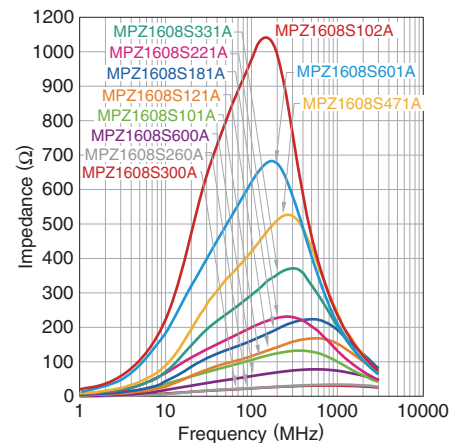
MPZ1608B type



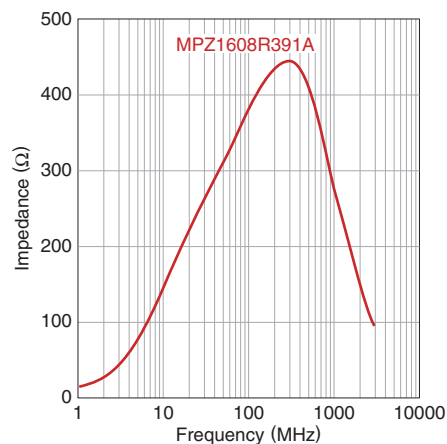
MPZ1608SPH type



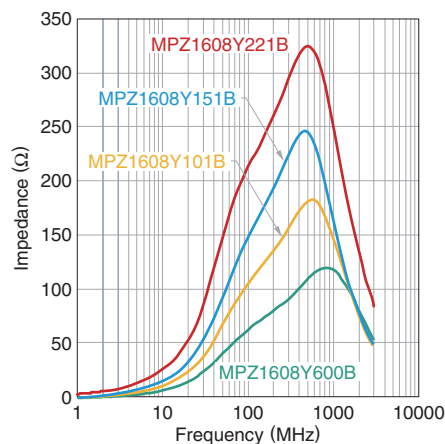
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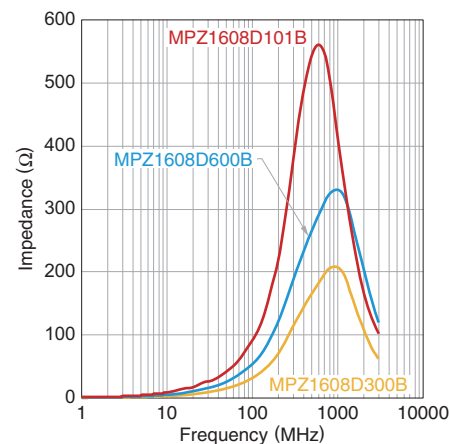
MPZ1608R type



MPZ1608Y type



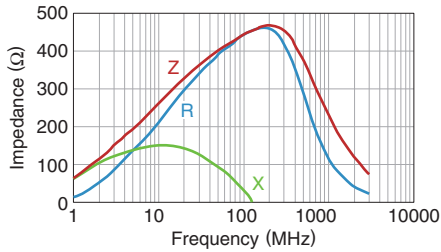
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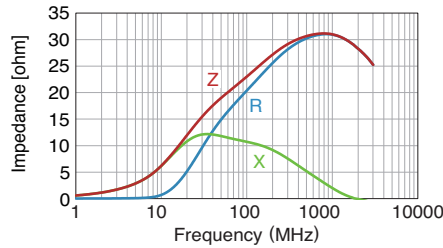
MPZ1608 type

Z, X, R VS. FREQUENCY CHARACTERISTICS

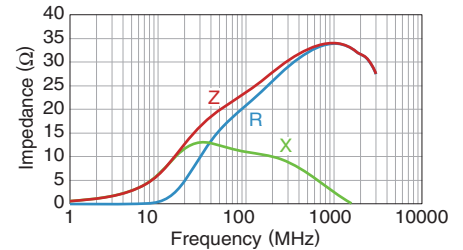
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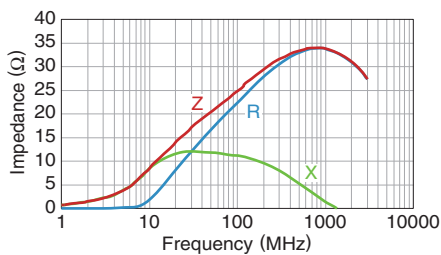
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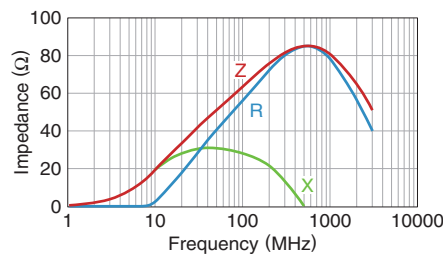
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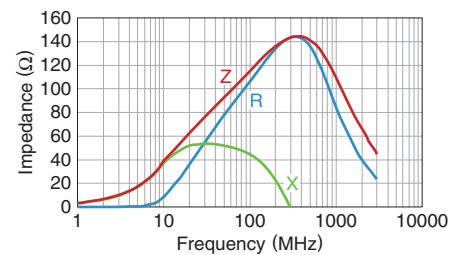
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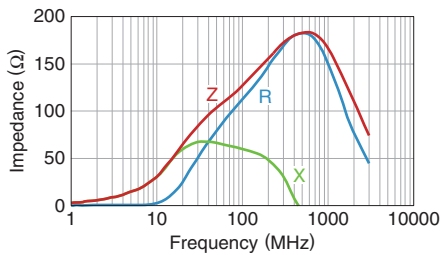
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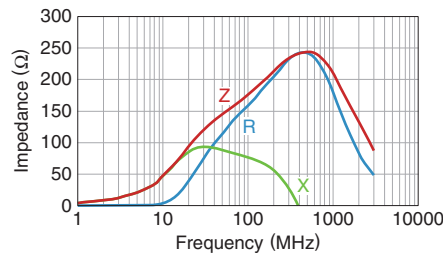
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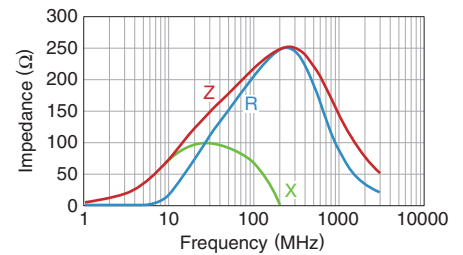
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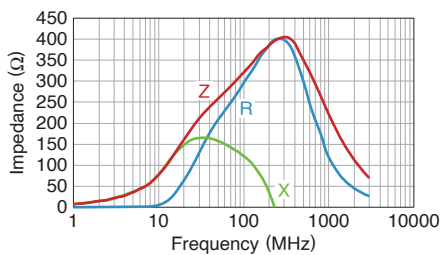
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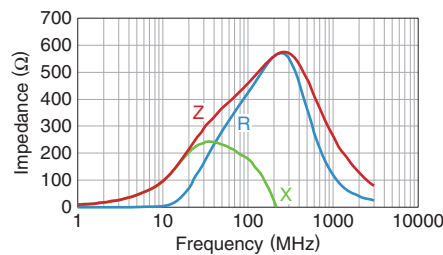
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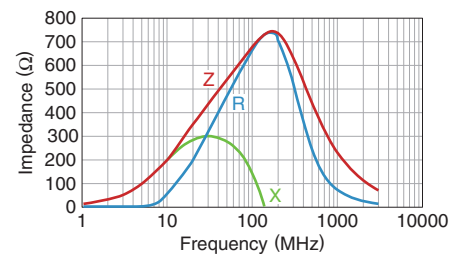
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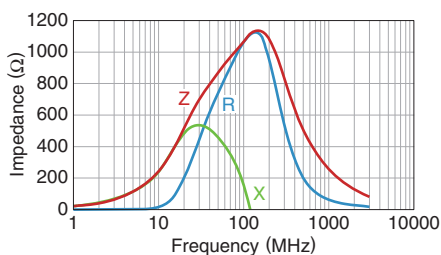
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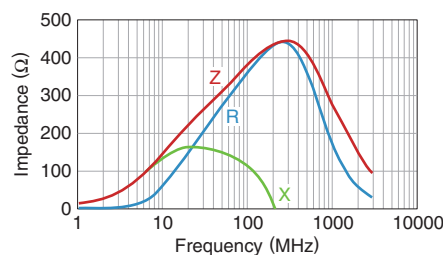
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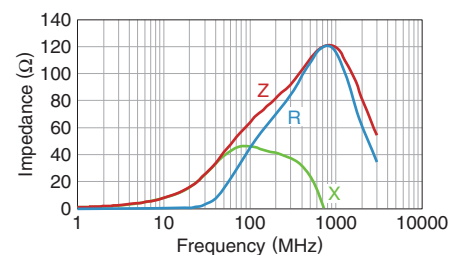
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MPZ1608R391ATA00



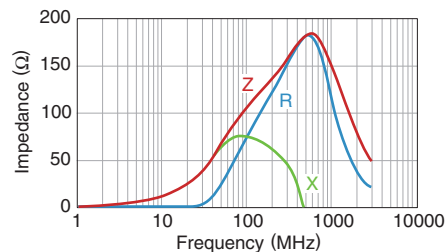
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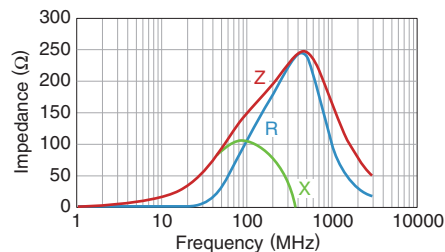
MPZ1608 type

Z, X, R VS. FREQUENCY CHARACTERISTICS

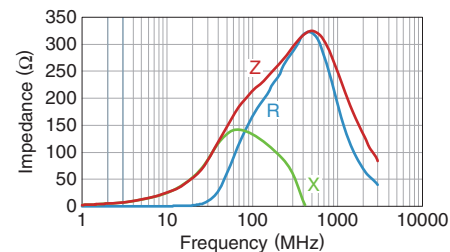
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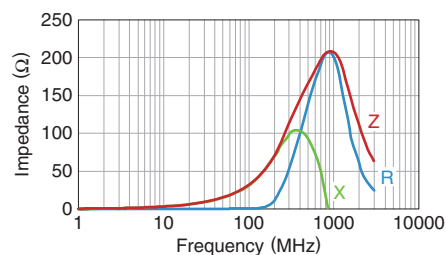
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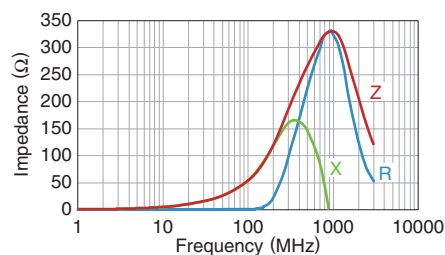
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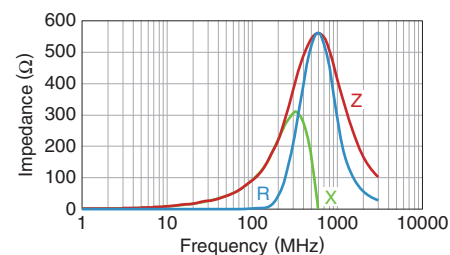
MPZ1608D300BTA00



MPZ1608D600BTA00



MPZ1608D101BTA00



■ SHAPE & DIMENSIONS



 Land Pattern (thickness: 35μm)

- Land Pattern + Solder Resist
- Solder Resist
- Land Pattern (thickness: 35μm)

Dimensions in mm

The graph illustrates the temperature profile over time for a heat treatment process. The y-axis represents Temperature, and the x-axis represents Time. The process is divided into four distinct stages:

- Preheating:** The temperature rises from 150°C to 180°C. This stage is shaded light blue and has a duration of 60 to 120 seconds.
- Soldering:** The temperature continues to rise from 180°C to the peak. This stage is also shaded light blue and has a duration of 30 to 60 seconds.
- Peak:** The temperature reaches its maximum, labeled as 250 to 260°C. This stage is shaded a darker blue and has a duration of 10 seconds.
- Natural cooling:** The temperature decreases from the peak back to 230°C. This stage is shaded light blue.

Key temperature points and durations are marked on the graph:

- 150°C: Starting temperature.
- 180°C: Temperature at the end of the preheating stage.
- 230°C: Temperature at the end of the soldering stage and at the end of the natural cooling stage.
- 250 to 260°C: Peak temperature.
- 60 to 120s: Duration of the preheating stage.
- 30 to 60s: Duration of the soldering stage.
- 10s: Duration of the peak stage.

Technical drawing of a circular mechanical part, showing a front view and a cross-sectional view.

Front View Dimensions:

- Outer diameter: $\phi 180 \pm 2.0$
- Central hole diameter: $\phi 13 \pm 0.2$
- Flange thickness: 2.0 ± 0.5
- Spoke thickness: 1.0
- Inner diameter of the central hub: $\phi 21 \pm 0.8$

Cross-sectional View Dimensions:

- Flange thickness: $8.4^{+2.0}_{-0.0}$
- Minimum central hole diameter: $\phi 60 \text{ min.}$
- Total width: 14.4 max.

Dimensions in mm

Dimensions in mm

Dimensions in mm

Package quantity	4,000 pcs/reel
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Type	Operating temperature range	Storage temperature range *	Individual weight
t=0.6mm	-55 to +125°C	-55 to +125°C	3 mg
t=0.8mm	-55 to +125°C	-55 to +125°C	4 mg

* Operating temperature range includes self-heating.

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products

REMINDERS

- The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- | | |
|---|--|
| (1) Aerospace/aviation equipment | (7) Transportation control equipment |
| (2) Transportation equipment (cars, electric trains, ships, etc.) | (8) Public information-processing equipment |
| (3) Medical equipment | (9) Military equipment |
| (4) Power-generation control equipment | (10) Electric heating apparatus, burning equipment |
| (5) Atomic energy-related equipment | (11) Disaster prevention/crime prevention equipment |
| (6) Seabed equipment | (12) Safety equipment |
| | (13) Other applications that are not considered general-purpose applications |

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.